Power MOSFET

40 V, 75 A, 9.3 m Ω , Single N-Channel

Features

- Low R_{DS(on)}
- Low Capacitance
- Optimized Gate Charge
- NVMFS5834NLWF Wettable Flanks Product
- NVMFS Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	40	V
Gate-to-Source Voltage			V_{GS}	±20	V
Continuous Drain		T _A = 25°C	I _D	14	Α
Current R _{θJA} (Note 1)		T _A = 100°C		12	
Power Dissipation	Steady	T _A = 25°C	P_{D}	3.6	W
R _{θJA} (Note 1)		T _A = 100°C		2.5	
Continuous Drain	State	T _C = 25°C	I _D	75	Α
Current R _{θJC} (Note 1)		T _C = 100°C		63	
Power Dissipation	1	T _C = 25°C	P_{D}	107	W
R _{θJC} (Note 1)		T _C = 100°C		75	
Pulsed Drain Current	t _p = 10 μs		I _{DM}	276	Α
Operating Junction and Storage Temperature			T _J , T _{STG}	–55 to +175	°C
Source Current (Body Diode)			I _S	75	Α
Single Pulse Drain-to-Source Avalanche			EAS	48	mJ
Energy (L = 0.1 mH)		IAS	31	Α	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)				260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Bottom) (Note 1)	$R_{\theta JC}$	1.4	
Junction-to-Case (Top) (Note 1)	$R_{\theta JC}$	4.5	°C/W
Junction-to-Ambient Steady State (Note 1)	$R_{\theta JA}$	41	C/VV
Junction-to-Ambient Steady State (Note 2)	$R_{\theta JA}$	75	

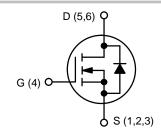
- Surface-mounted on FR4 board using 1 sq-in pad (Cu area = 1.127 in sq [2 oz] including traces).
- 2. Surface-mounted on FR4 board using 0.155 in sq (100mm²) pad size.



ON Semiconductor®

http://onsemi.com

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	9.3 m Ω @ 10 V	75 A
40 V	13.6 mΩ @ 4.5 V	75 A

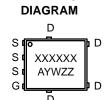


N-CHANNEL MOSFET



DFN5 (SO-8FL) CASE 488AA STYLE 1

W



MARKING

Α = Assembly Location

Υ

= Work Week

= Lot Traceability

ORDERING INFORMATION

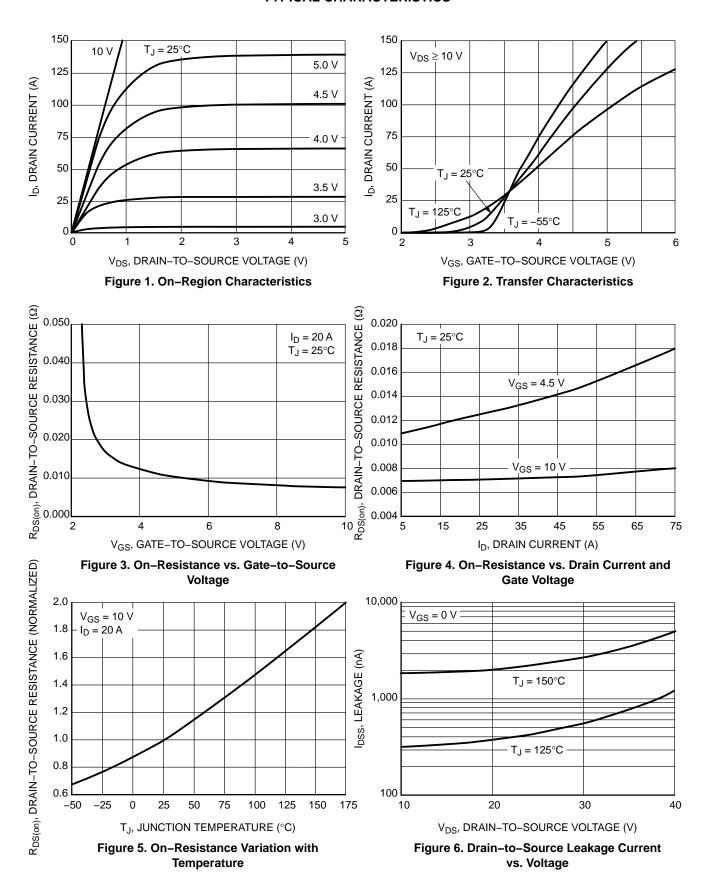
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS					•	•	•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				34.7		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 40 V	T _J = 25 °C			1.0	μΑ
		$V_{DS} = 40 \text{ V}$	T _J = 125°C			100	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS}$	= ±20 V			±100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 250 \mu A$		1.0		3.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J	·			5.7		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 20 A		7.1	9.3	
		V _{GS} = 4.5 V	I _D = 20 A		11.3	13.6	mΩ
Forward Transconductance	9FS	V _{DS} = 5 V, I _D = 20 A			29		S
CHARGES, CAPACITANCES & GATE RESIS	STANCE						
Input Capacitance	C _{ISS}				1231		
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1 MH.	z, V _{DS} = 20 V		198		pF
Reverse Transfer Capacitance	C _{RSS}				141]
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 20 V; I _D = 20 A			24		
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = 4.5 \text{ V}, V_{DS} = 20 \text{ V}; I_D = 20 \text{ A}$			12		nC
Threshold Gate Charge	Q _{G(TH)}				1.0		
Gate-to-Source Charge	Q_{GS}				4.2		
Gate-to-Drain Charge	Q_{GD}				6.3		
Plateau Voltage	V_{GP}				3.4		V
Gate Resistance	R_{G}				0.7		Ω
SWITCHING CHARACTERISTICS (Note 4)							
Turn-On Delay Time	t _{d(ON)}	$V_{GS} = 4.5 \text{ V}, V_{DS} = 20 \text{ V},$ $I_{D} = 20 \text{ A}, R_{G} = 2.5 \Omega$			10		- ns
Rise Time	t _r				56.4		
Turn-Off Delay Time	t _{d(OFF)}				17.4		
Fall Time	t _f				6.6		
DRAIN-SOURCE DIODE CHARACTERISTIC	s						•
Forward Diode Voltage	V_{SD}	V _{GS} = 0 V.	$T_J = 25^{\circ}C$		0.84	1.2	.,
		$V_{GS} = 0 \text{ V},$ $I_{S} = 20 \text{ A}$	T _J = 125°C		0.72		_ V
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V, dIS/dt} = 100 \text{ A/}\mu\text{s,}$ $I_{S} = 20 \text{ A}$			18		ns
Charge Time	t _a				10		
Discharge Time	t _b				8.0		
Reverse Recovery Charge	Q _{RR}				11		nC

^{3.} Pulse Test: pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$. 4. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

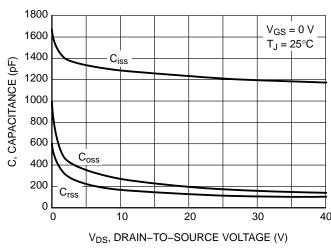


Figure 7. Capacitance Variation

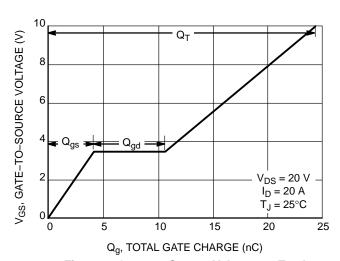


Figure 8. Gate-to-Source Voltage vs. Total Charge

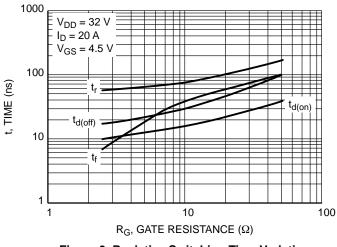


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

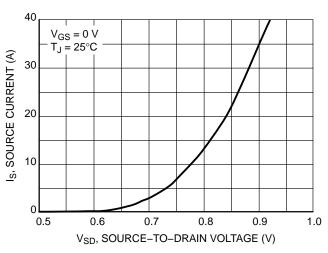


Figure 10. Diode Forward Voltage vs. Current

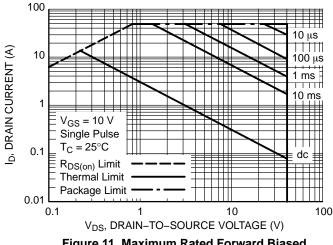


Figure 11. Maximum Rated Forward Biased Safe Operating Area

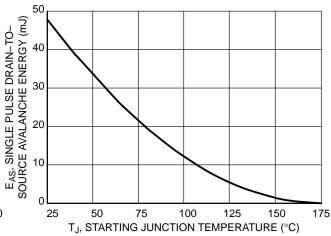


Figure 12. Maximum Avalanche Energy vs. Starting Junction Temperature

TYPICAL CHARACTERISTICS

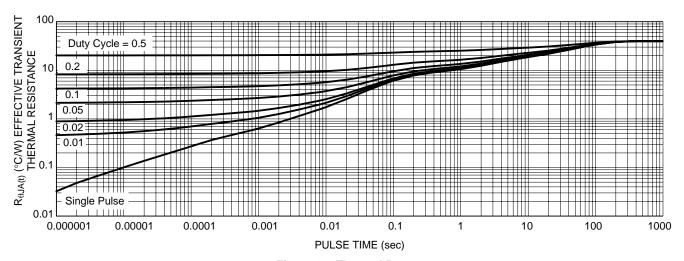


Figure 13. Thermal Response

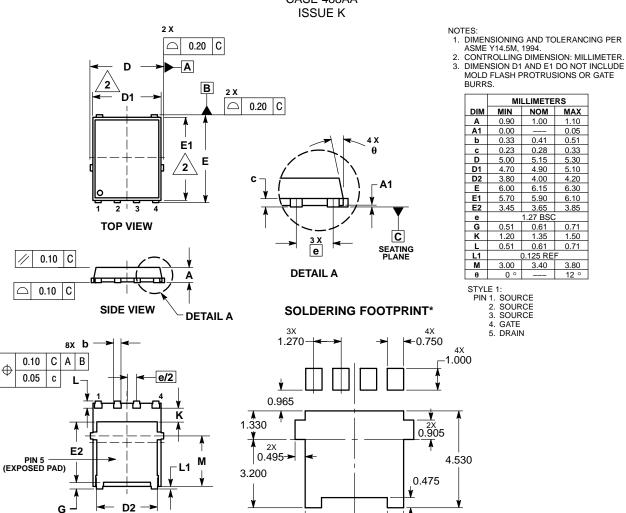
DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMFS5834NLT1G	5834L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5834NLT1G	V5834L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5834NLWFT1G	5834LW	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5834NLT3G	V5834L	DFN5 (Pb-Free)	5000 / Tape & Reel
NVMFS5834NLWFT3G	5834LW	DFN5 (Pb-Free)	5000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS





*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

4.560

2X **→** 1.530

ON Semiconductor and Up are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA **Phone**: 303–675–2175 or 800–344–3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

BOTTOM VIEW

N. American Technical Support: 800-282-9855 Toll Free

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

1.10

0.05

0.51

0.33

5.30

5.10

4.20 6.30

6.10

3.85

0.71

0.71

3.80

12 °

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ON Semiconductor: NVMFS5834NLT1G